

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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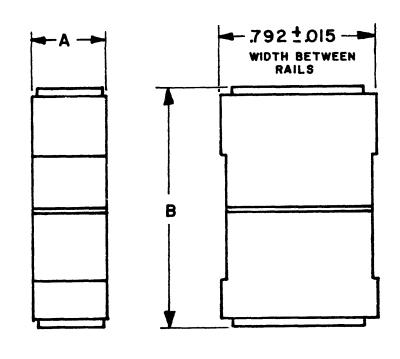


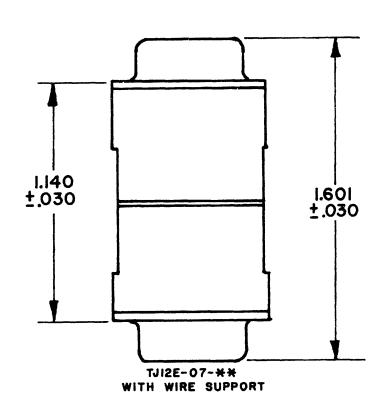




	TJ12E -**-**	REVISIONS				
i		SYM	DESCRIPTION	DATE	APPROVED	
		F	REV & REDR PER E.O. 54072	10-30-68	2.98. 11-14-68	
		G	REV (I) PER E.O. 54097	2-4-68	2.9. B\$1.	

PART NUMBER	SIZE	WT. IN LBS. APPROX.	A ±.015	B ±.030
TJ12E-06-**	22	.026	. 394	1.226
TJ12E-02-**	20	.029	.394	1.290
TJ12E-05-**	16	.068	.980	1.302
TJ12E-07-**	12	.102	1.274	1.433





- 6. FOR CONTACT DATA SEE ENV. DWG. 61800.
- 5. MODULE ASSEMBLY WEIGHTS SHOWN INCLUDE 16 CONTACTS FOR SIZES 20, 16, & 12 AND 20 CONTACTS FOR SIZE 22.
- 4. TJ12E-**-**
 BUS ARRANGEMENT
 MODULE SIZE
- 3. THESE MODULE SIZES MAY BE USED IN SIZE 1 FRAME ONLY.
- 2. THE BUS IDENTIFICATION WILL BE SCREENED ON MODULE ASSY. FOR AVAILABLE MODULE ARRANGEMENTS SEE CATALOG ENVELOPE DWGS. 61510, 61511, 61512, & 61514.
- 1. SEE "GENERAL DESCRIPTION" FOR ELECTRICAL AND MATERIAL SPECIFICATION.

NOTES:

°/29/68	SIGNATURE & DATE		
DR	R. BARTLEY		
снк	3.2. Licha 11-14-68		
PE 19 Block 1/4/61			
APPD			
SCALE	NONE WT		

MODULE ASSEMBLY
FEED-THRU JUNCTION
SIZE 22, 20, 16 & 12
TYPE 2
ENVIRONMENTAL

ENVELOPE

		IC COMPONENTS DIVISION Municipal Airport Banning, California		
В	TJI2E	-**- * *		
DWG SIZE	CODE 11139	SHEET OF		